

SGM11103S High Isolation SP3T Switch

GENERAL DESCRIPTION

The SGM11103S is a 2-bit control single-pole/threethrow (SP3T) switch, which supports from 0.1GHz to 5.8GHz. The device features low control voltage and high isolation.

The SGM11103S has the ability to integrate the ESD protection circuits to achieve high ESD tolerance.

No external DC blocking capacitors are required on the RF paths as long as no external DC voltage is applied, which can save PCB area and cost.

The SGM11103S is available in a Green ULGA-1.15× 1.55-10L package.

APPLICATIONS

Multi-Mode 2G/3G/4G/5G and Receive System Applications Pre PA Switching, Reception Bands Switching Applications General Purpose Switching Applications Feedback RX Applications

FEATURES

- High Isolation:
 - $f_0 = 1.0GHz$, $P_{IN} = 0dBm$: 55dB (TYP)
 - $f_0 = 2.0GHz, P_{IN} = 0dBm: 52dB (TYP)$
 - $f_0 = 2.7 GHz$, $P_{IN} = 0 dBm$: 50 dB (TYP)
 - $f_0 = 3.8GHz, P_{IN} = 0dBm: 48dB (TYP)$
 - f₀ = 5.8GHz, P_{IN} = 0dBm: 34dB (TYP)
- Low Insertion Loss:
 - f₀ = 1.0GHz, P_{IN} = 0dBm: 0.49dB (TYP)
 - f₀ = 2.0GHz, P_{IN} = 0dBm: 0.52dB (TYP)
 - $f_0 = 2.7 GHz, P_{IN} = 0 dBm: 0.56 dB (TYP)$
 - f₀ = 3.8GHz, P_{IN} = 0dBm: 0.60dB (TYP)
 - f₀ = 5.8GHz, P_{IN} = 0dBm: 1.07dB (TYP)
- Available in a Green ULGA-1.15×1.55-10L Package

BLOCK DIAGRAM



Figure 1. SGM11103S Block Diagram

PACKAGE/ORDERING INFORMATION

MODEL	PACKAGE DESCRIPTION	SPECIFIED TEMPERATURE RANGE	ORDERING NUMBER	PACKAGE MARKING	PACKING OPTION
SGM11103S	ULGA-1.15×1.55-10L	41.55-10L -40°C to +85°C SGM11103SYULJ10G/TR		ZX XX	Tape and Reel, 5000

MARKING INFORMATION

NOTE: XX = Date Code.

YY — Serial Number X X							
TT_	Date Code - Week						
	Date Code - Year						

Green (RoHS & HSF): SG Micro Corp defines "Green" to mean Pb-Free (RoHS compatible) and free of halogen substances. If you have additional comments or questions, please contact your SGMICRO representative directly.

ABSOLUTE MAXIMUM RATINGS

Supply Voltage, V _{DD}	3.6V
Control Voltage, V _{CTL}	3.6V
RF Input Power, P _{IN} (f ₀ = 2.7GHz)	30dBm
Junction Temperature	+150°C
Storage Temperature Range	55°C to +150°C
Lead Temperature (Soldering, 10s)	+260°C
ESD Susceptibility	
HBM	1000V

RECOMMENDED OPERATING CONDITIONS

Operating Temperature Range	40°C to +85°C
Operating Frequency Range, f ₀	0.1GHz to 5.8GHz
Supply Voltage, V _{DD}	2.5V to 3.3V
Control High Voltage, V _{CTL_H}	1.35V to 3.3V
Control Low Voltage, V _{CTL_L}	0V to 0.3V

OVERSTRESS CAUTION

Stresses beyond those listed in Absolute Maximum Ratings may cause permanent damage to the device. Exposure to absolute maximum rating conditions for extended periods may affect reliability. Functional operation of the device at any conditions beyond those indicated in the Recommended Operating Conditions section is not implied.

ESD SENSITIVITY CAUTION

This integrated circuit can be damaged if ESD protections are not considered carefully. SGMICRO recommends that all integrated circuits be handled with appropriate precautions. Failure to observe proper handling and installation procedures can cause damage. ESD damage can range from subtle performance degradation to complete device failure. Precision integrated circuits may be more susceptible to damage because even small parametric changes could cause the device not to meet the published specifications.

DISCLAIMER

SG Micro Corp reserves the right to make any change in circuit design, or specifications without prior notice.



PIN CONFIGURATION



ULGA-1.15×1.55-10L

PIN DESCRIPTION

PIN	NAME	FUNCTION
1	RFCOM	RF Common Port.
2, 5, 10	GND	Ground Terminal. Please connect this terminal with ground plane as close as possible for excellent RF performance.
3	VDD	DC Power Supply. Please connect a bypass capacitor with GND terminal for excellent RF performance.
4	RF1	RF I/O Port 1.
6	RF2	RF I/O Port 2.
7	VCTL1	DC Control Voltage 1. Please connect a bypass capacitor with GND terminal for excellent RF performance.
8	VCTL2	DC Control Voltage 2. Please connect a bypass capacitor with GND terminal for excellent RF performance.
9	RF3	RF I/O Port 3.

LOGIC TRUTH TABLE

VCTL1	VCTL2	ON PATH
High	Low	RFCOM-RF1
Low	High	RFCOM-RF2
High	High	RFCOM-RF3
Low	Low	X

X = Don't care.



ELECTRICAL CHARACTERISTICS

 $(T_A = +25^{\circ}C, V_{DD} = 2.5V \text{ to } 3.3V, \text{ typical values are at } V_{DD} = 2.8V, P_{IN} = 0dBm, \text{ input and output resistance} = 50\Omega, V_{CTL_L} = 0V, V_{CTL_H} = 1.8V, \text{ unless otherwise noted.}$

PARAMETER	SYMBOL	CONDITIONS	MIN	ТҮР	MAX	UNITS	
DC Characteristics				•		•	
Supply Voltage	V _{DD}		2.5	2.8	3.3	V	
Supply Current	I _{VDD}			20	45	μA	
Control Voltage	V _{CTL_L}		0	0	0.3	V	
Control Voltage	V _{CTL_H}		1.35	1.8	3.3	V	
Control Current	I _{CTL}	V _{CTL_H} = 1.8V		2	8	μA	
Switching Time	t _{sw}	50% V _{CTL} to 10/90% RF		1	2	μs	
RF Characteristics						-	
	IL	f ₀ = 1.0GHz, P _{IN} = 0dBm		0.49	0.79	dB	
		f ₀ = 2.0GHz, P _{IN} = 0dBm		0.52	0.82		
Insertion Loss		f ₀ = 2.7GHz, P _{IN} = 0dBm		0.56	0.86		
		f ₀ = 3.8GHz, P _{IN} = 0dBm		0.60	0.97		
		f ₀ = 5.8GHz, P _{IN} = 0dBm		1.07	1.45		
		f ₀ = 1.0GHz, P _{IN} = 0dBm	47	55		1	
		f ₀ = 2.0GHz, P _{IN} = 0dBm	44	52			
Isolation (RFCOM to All RF Ports)	ISO	f ₀ = 2.7GHz, P _{IN} = 0dBm	38	50		dB	
		f ₀ = 3.8GHz, P _{IN} = 0dBm	35	48			
		f ₀ = 5.8GHz, P _{IN} = 0dBm	26	34			
Input Power at 0.1dB	_	f ₀ = 0.1GHz to 3.0GHz		30		dDat	
Compression Point	$P_{0.1dB}$	f ₀ = 3.0GHz to 5.8GHz		28		dBm	
Vellene Chanding Marie Detie		f ₀ = 0.1GHz to 3.0GHz		1.2			
Voltage Standing Wave Ratio	VSWR	f ₀ = 3.0GHz to 5.8GHz		1.6]	



TYPICAL APPLICATION CIRCUIT



Figure 2. SGM11103S Typical Application Circuit

EVALUATION BOARD LAYOUT



Figure 3. SGM11103S Evaluation Board Layout



PACKAGE OUTLINE DIMENSIONS ULGA-1.15×1.55-10L

PIN 1#



TOP VIEW

BOTTOM VIEW





SIDE VIEW

RECOMMENDED LAND PATTERN (Unit: mm)

Symbol	Diı	nensions In Millimet	ers					
Symbol	MIN	MOD	МАХ					
А	0.460	0.500	0.540					
A1		0.170 REF						
A2		0.330 REF						
b	0.150	0.150 0.200						
b1	0.100	0.100 0.150						
D	1.100	1.100 1.150						
E	1.500 1.550		1.600					
е		0.400 BSC						
e1		0.400 BSC						
L	0.150	0.200	0.250					
L1	0.150	0.200	0.250					
L2	-	- 0.175 -						

NOTE: This drawing is subject to change without notice.



TAPE AND REEL INFORMATION

REEL DIMENSIONS



NOTE: The picture is only for reference. Please make the object as the standard.

KEY PARAMETER LIST OF TAPE AND REEL

Package Type	Reel Diameter	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P0 (mm)	P1 (mm)	P2 (mm)	W (mm)	Pin1 Quadrant
ULGA-1.15×1.55-10L	7″	9.5	1.30	1.70	0.60	4.0	4.0	2.0	8.0	Q1



CARTON BOX DIMENSIONS



NOTE: The picture is only for reference. Please make the object as the standard.

KEY PARAMETER LIST OF CARTON BOX

Reel Type	Length (mm)	Width (mm)	Height (mm)	Pizza/Carton	
7" (Option)	368	227	224	8	
7"	442	410	224	18	DD0002

